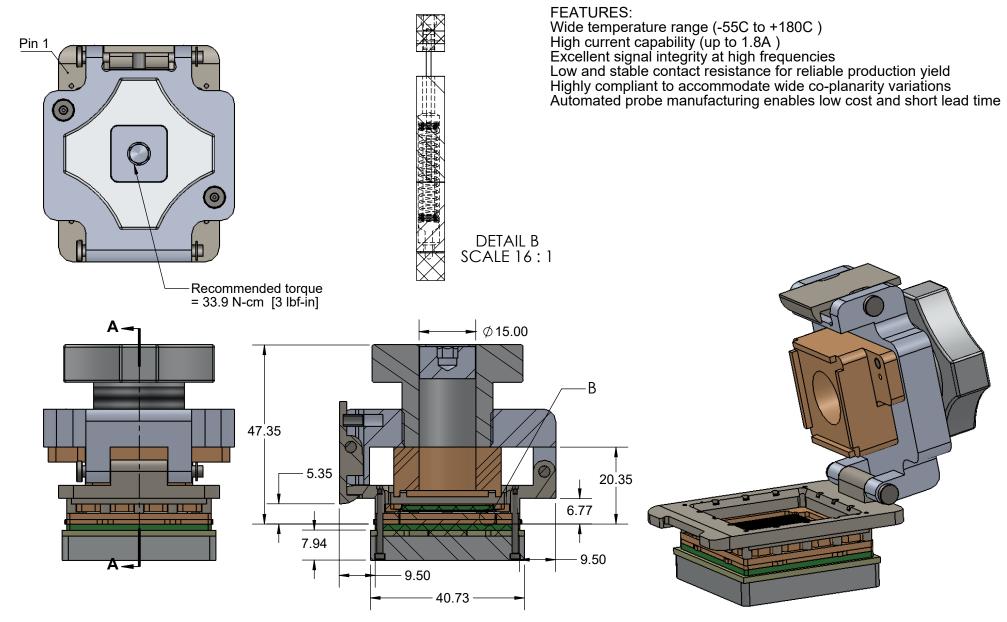
SBT-BGA DIRECT MOUNT, SOLDERLESS SOCKET FOR BURN-IN AND TEST APPLICATIONS



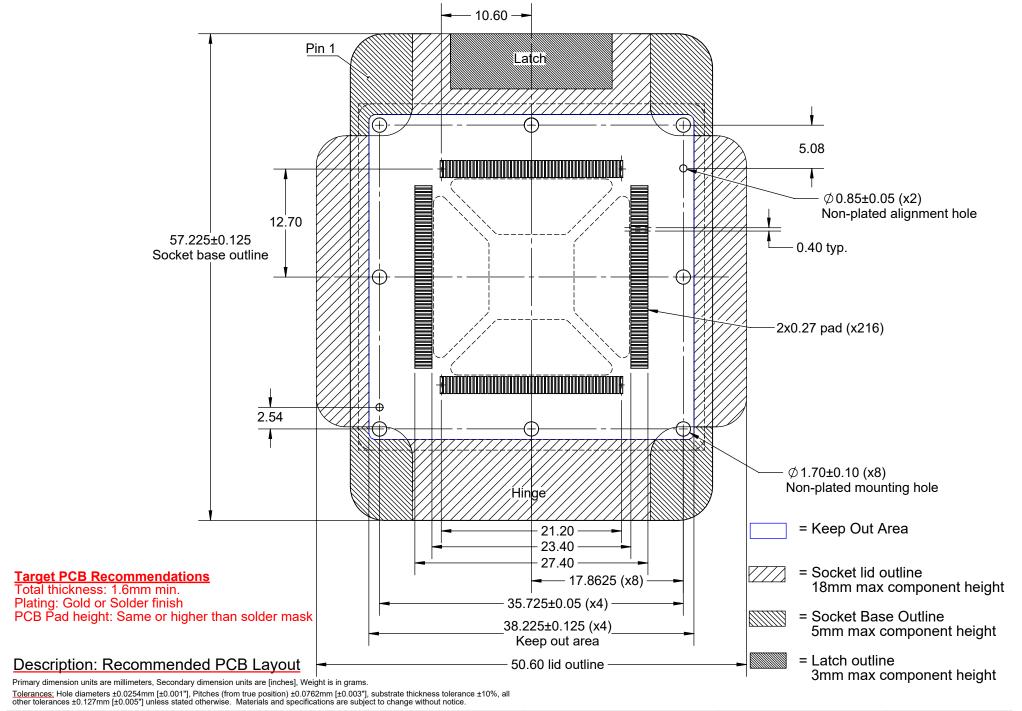
Description: CBT-QFP216 26mm T2T 0.4mm pitch

SECTION A-A

Primary dimension units are millimeters, Secondary dimension units are [inches], Weight is in grams.

Tolerances: Hole diameters ±0.03mm [±0.001"], Pitches (from true position) ±0.025mm [±0.001"], substrate thickness tolerance ±10%, all other tolerances ±0.13mm [±0.005"] unless stated otherwise. Materials and specifications are subject to change without notice.

CBT-QFE-3006 Drawing	Material: N/A Finish: N/A Weight: 179.76	STATUS: Released	SHEET: 1 OF 4	REV. A
Ironwood Electronics, Inc. Tele: (800) 404-0204 www.ironwoodelectronics.com		ENG: S. Huang	DRAWN BY: M. Raske	SCALE: 1:1
		FILE: CBT-QFE-3006 Dwg	DATE: 09/18/2015	

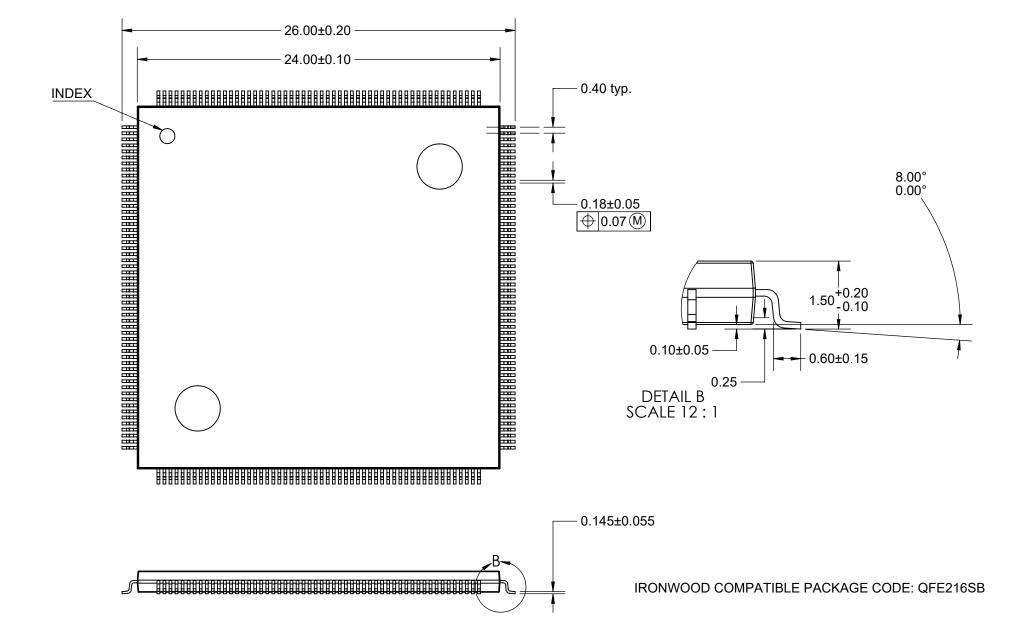


CBT-QFE-3006 Drawing

Ironwood Electronics, Inc. Tele: (800) 404-0204 www.ironwoodelectronics.com Material: N/A Finish: N/A Weight: 179.76
 STATUS: Released
 SHEET: 2 OF 4
 REV. A

 ENG: S. Huang
 DRAWN BY: M. Raske
 SCALE: 2.25:1

 FILE: CBT-QFE-3006 Dwg
 DATE: 09/18/2015



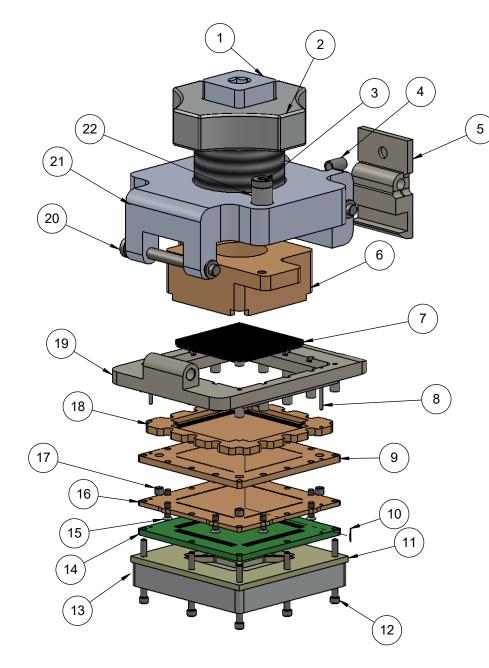
- 1. Dimensions are in millimeters.
- 2. Interpret dimensions and tolerances per ASME Y14.5M-1994.

Description: Compatible IC

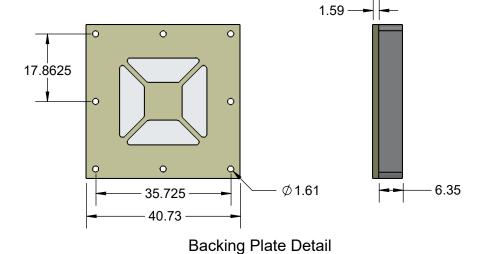
Primary dimension units are millimeters, Secondary dimension units are [inches], Weight is in grams.

Tolerances: Hole diameters ±0.03mm [±0.001"], Pitches (from true position) ±0.025mm [±0.001"], substrate thickness tolerance ±10%, all other tolerances ±0.13mm [±0.005"] unless stated otherwise. Materials and specifications are subject to change without notice.

CBT-QFE-3006 Drawing Material: N/A STATUS: Released SHEET: 3 OF 4 REV. A Ironwood Electronics, Inc. Tele: (800) 404-0204 www.ironwoodelectronics.com Finish: N/A Weight: 179.76 ENG: S. Huang DRAWN BY: M. Raske SCALE: 4:1 FILE: CBT-QFE-3006 Dwg DATE: 09/18/2015



ITEM NO.	DESCRIPTION	Material	
1	Compression Screw block	Aluminum	
2	Compression Screw	Aluminum	
3	Lid Screw	Steel	
4	Latch spring	Steel	
5	Latch	Aluminum	
6	Compression Plate	High Temp Plastic	
7	Compatible IC	N/A	
8	Alignment Pin	Steel	
9	Middle Guide	High Temp Plastic	
10	Spring Pin	N/A	
11	Insulating Plate	High Temp Plastic	
12	Mounting Screw	Steel	
13	Backing Plate	Aluminum	
14	Target PCB	N/A	
15	Pin Guide Screw	High Temp Plastic	
16	Bottom Guide	Semitron MDS 100	
17	Floating Guide Spring	Steel	
18	Floating Guide	Semitron MDS 100	
19	Socket Base	Aluminum	
20	Hinge Pin and Snap Ring	Steel	
21	Lid	Aluminum	
22	Lid spring	Steel	



Description: Socket Assy, Insulation Plate

Primary dimension units are millimeters, Secondary dimension units are [inches], Weight is in grams.

Tolerances: Hole diameters ±0.03mm [±0.001"], Pitches (from true position) ±0.025mm [±0.001"], substrate thickness tolerance ±10%, all other tolerances ±0.13mm [±0.005"] unless stated otherwise. Materials and specifications are subject to change without notice.

CBT-QFE-3006 Drawing

Ironwood Electronics, Inc.
Tele: (800) 404-0204
www.ironwoodelectronics.com

Material: N/A Finish: N/A Weight: 179.76

STATUS: Released	SHEET: 4 OF 4	REV. A
ENG: S. Huang	DRAWN BY: M. Raske	SCALE: 1:1
FILE: CBT-QFE-3006 Dwg	DATE: 09/18/2015	